#### 查询ADG431供应商

## ANALOG DEVICES

# LC<sup>2</sup>MOS Precision Quad SPST Switches

FUNCTIONAL BLOCK DIAGRAMS

专业PCB打样工厂

# ADG431/ADG432/ADG433

,24小时加急出货

#### FEATURES

44 V Supply Maximum Ratings  $\pm 15$  V Analog Signal Range Low On Resistance (<24  $\Omega$ ) Ultralow Power Dissipation (3.9  $\mu$ W) Low Leakage (<0.25 nA) Fast Switching Times  $t_{ON}$  <165 ns  $t_{OFF}$  <130 ns Break-Before-Make Switching Action TTL/CMOS Compatible Plug-in Replacement for DG411/DG412/DG413

APPLICATIONS Audio and Video Switching Automatic Test Equipment Precision Data Acquisition Battery Powered Systems Sample Hold Systems Communication Systems

#### 0.51 0.51 O D1 O D1 -0 S2 **O** S2 IN2 O IN2 C O D2 0 D2 ADG43 ADG432 -O S3 O S3 IN3 C IN3 C -0 D3 003 O S4 **O** S4 IN4 C O D1 S2 IN<sub>2</sub> C 0 D2 ADG433 S3 IN3 C O D3 O S4 IN4 C SWITCHES SHOWN FOR A LOGIC "1" INPUT

#### **GENERAL DESCRIPTION**

**BEV**BDF

The ADG431, ADG432 and ADG433 are monolithic CMOS devices comprising four independently selectable switches. They are designed on an enhanced  $LC^2MOS$  process which provides low power dissipation yet gives high switching speed and low on resistance.

The on resistance profile is very flat over the full analog input range ensuring excellent linearity and low distortion when switching audio signals. Fast switching speed coupled with high signal bandwidth also make the parts suitable for video signal switching. CMOS construction ensures ultralow power dissipation making the parts ideally suited for portable and battery powered instruments.

The ADG431, ADG432 and ADG433 contain four independent SPST switches. The ADG431 and ADG432 differ only in that the digital control logic is inverted. The ADG431 switches are turned on with a logic low on the appropriate control input, while a logic high is required for the ADG432. The ADG433 has two switches with digital control logic similar to that of the ADG431 while the logic is inverted on the other two switches.

Each switch conducts equally well in both directions when ON and has an input signal range which extends to the supplies. In the OFF condition, signal levels up to the supplies are blocked. All switches exhibit break before make switching action for use in multiplexer applications. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.

#### PRODUCT HIGHLIGHTS

1. Extended Signal Range

The ADG431, ADG432 and ADG433 are fabricated on an enhanced LC<sup>2</sup>MOS process giving an increased signal range which extends fully to the supply rails.

- 2. Ultralow Power Dissipation
- 3. Low R<sub>ON</sub>
- 4. Break-Before-Make Switching This prevents channel shorting when the switches are configured as a multiplexer.
- 5. Single Supply Operation For applications where the analog signal is unipolar, the

ADG431, ADG432 and ADG433 can be operated from a single rail power supply. The parts are fully specified with a single +12 V power supply and will remain functional with single supplies as low as +5 V.

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# ADG431/ADG432/ADG433-SPECIFICATIONS<sup>1</sup>

**Dual Supply** ( $V_{DD} = +15 V \pm 10\%$ ,  $V_{SS} = -15 V \pm 10\%$ ,  $V_L = +5 V \pm 10\%$ , GND = 0 V, unless otherwise noted)

B Versions -40°C to		T Versions -55°C to			
+25°C	+85°C	+25°C	+125°C	Units	<b>Test Conditions/Comments</b>
	$V_{DD}$ to $V_{SS}$		$V_{DD}$ to $V_{SS}$	V	
17	22 00	17	22 00	$\Omega$ typ	$V_{\rm D} = \pm 8.5 \text{ V}, I_{\rm S} = -10 \text{ mA};$
24	26	24	27	$\Omega$ max	$V_{DD} = +13.5 \text{ V}, V_{SS} = -13.5 \text{ V}$
15		15		% typ	
0.5		0.5			
5		5		% typ	$V_{\rm D} = 0 \text{ V}, \text{ I}_{\rm S} = -10 \text{ mA}$
					$V_{DD} = +16.5 \text{ V}, V_{SS} = -16.5 \text{ V}$
+0.05		+0.05		nA typ	$V_D = \pm 15.5 \text{ V}, V_S = \pm 15.5 \text{ V};$ $V_D = \pm 15.5 \text{ V}, V_S = \pm 15.5 \text{ V};$
	+2		+15		Test Circuit 2
	± 2		±15		$V_{\rm D} = \pm 15.5 \text{ V}, V_{\rm S} = \mp 15.5 \text{ V};$
	+2		+15		Test Circuit 2
	± <b>2</b>		±19		$V_{\rm D} = V_{\rm S} = \pm 15.5 \text{ V};$
	+3		+17		Test Circuit 3
_0.55		_0.55			
	0.4		0.4		
	0.8		0.8	v max	
0.005		0.005			X7 _ X7 X7
0.005	10.02	0.005	10.02		$V_{IN} = V_{INL}$ or $V_{INH}$
0	±0.02	0	±0.02		
9		9		pr typ	
					$V_{DD} = +15 V, V_{SS} = -15 V$
90		90		ns typ	$R_L = 300 \Omega, C_L = 35 pF;$
	165		175		$V_s = \pm 10 V$ ; Test Circuit 4
60	1.0.0	60		• •	$R_L = 300 \Omega, C_L = 35 pF;$
25	130	25	145		$V_s = \pm 10 V$ ; Test Circuit 4
25		25		ns typ	$R_L = 300 \Omega, C_L = 35 pF;$
					$V_{S1} = V_{S2} = +10 V;$
5		5		n C trun	Test Circuit 5 V = 0 V R = 0 0 C = 10 rF
5		5		pC typ	$V_S = 0 V, R_S = 0 \Omega, C_L = 10 nF;$ Test Circuit 6
69		69		dP turn	$R_L = 50 \Omega, C_L = 5 pF, f = 1 MHz$
00		00		ubtyp	Test Circuit 7
85		85		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$
		05		ubtyp	Test Circuit 8
9		9		pF typ	f = 1 MHz
					f = 1 MHz
-		35			f = 1 MHz
				r Jr	
					$V_{DD}$ = +16.5 V, $V_{SS}$ = -16.5 V Digital Inputs = 0 V or 5 V
0.0001		0.0001			Digital inputs – 0 v or 5 v
	0.2		0.2		
	0.2		0.2		
	0.2		0.2		
	0.2		0.2	•	
0 0001					
0.0001	0.2	0.0001	0.2	μA typ μA max	
	$ \begin{array}{c} 17\\24\\15\\0.5\\5\\\end{array}\\ \pm 0.05\\\pm 0.25\\\pm 0.05\\\pm 0.25\\\pm 0.1\\\pm 0.35\\\end{array}\\ 0.005\\9\\90\\60\\\end{array} $	$\begin{array}{cccc} & V_{DD} \text{ to } V_{SS} \\ 17 \\ 24 \\ 15 \\ 0.5 \\ 5 \end{array} & \begin{array}{c} 26 \\ 15 \\ 0.5 \\ 5 \end{array} \\ \begin{array}{c} \pm 0.05 \\ \pm 0.25 \\ \pm 2 \\ \pm 0.05 \\ \pm 0.25 \\ \pm 2 \\ \pm 0.1 \\ \pm 0.35 \end{array} \\ \begin{array}{c} \pm 2 \\ \pm 0.1 \\ \pm 0.35 \end{array} \\ \begin{array}{c} \pm 2 \\ \pm 0.1 \\ \pm 0.02 \end{array} \\ \begin{array}{c} 9 \\ 90 \\ 165 \\ 60 \\ 130 \\ 25 \end{array} \\ \begin{array}{c} 9 \\ 90 \\ 165 \\ 60 \\ 130 \\ 25 \end{array} \\ \begin{array}{c} 5 \\ 68 \\ 85 \\ 9 \\ 9 \\ 9 \\ 35 \end{array} \\ \begin{array}{c} 0.0001 \\ 0.1 \\ 0.0001 \\ 0.1 \\ 0.02 \end{array} \\ \begin{array}{c} 0.0001 \\ 0.2 \\ 0.0001 \end{array} \\ \begin{array}{c} 0.02 \\ 0.2$	+25°C       +85°C       +25°C $V_{DD}$ to $V_{SS}$ 17         24       26       17         24       26       17         15       0.5       5 $0.05$ $\pm 2$ $\pm 0.05$ $\pm 0.05$ $\pm 2$ $\pm 0.05$ $\pm 0.25$ $\pm 2$ $\pm 0.05$ $\pm 0.25$ $\pm 2$ $\pm 0.1$ $\pm 0.1$ $\pm 0.35$ $\pm 0.1$ $\pm 0.35$ $\pm 3$ $0.005$ $\pm 0.1$ $\pm 0.35$ $\pm 0.35$ $0.005$ $\pm 0.02$ $9$ $90$ $0.005$ $90$ $90$ $165$ $60$ $25$ $5$ $5$ $5$ $5$ $68$ $85$ $9$	+25°C+85°C+25°C+125°C+1125°C $V_{DD}$ to $V_{SS}$ 1724271724261724150.55150.55515 $\pm 0.05$ $\pm 2$ $\pm 0.05$ $\pm 15$ $\pm 0.05$ $\pm 2$ $\pm 0.05$ $\pm 15$ $\pm 0.05$ $\pm 2$ $\pm 0.25$ $\pm 15$ $\pm 0.35$ $\pm 3$ $\pm 0.35$ $\pm 17$ 2.40.80.005 $\pm 0.02$ 9901651756013025255556868858599993535	+25°C+85°C+25°C+125°CUnits $V_{DD}$ to $V_{SS}$ $V_{DD}$ to $V_{SS}$ $V_{\Omega}$ typ $\Omega$ max1726172427 $\Omega$ max150.559 $\gamma$ typ0.5515 $N$ typ $0.5$ $\pm 0.05$ $\pm 0.05$ $\pm 0.05$ $\pi$ max $\pm 0.25$ $\pm 2$ $\pm 0.25$ $\pm 15$ $\pi$ max $\pm 0.25$ $\pm 2$ $\pm 0.25$ $\pm 15$ $\pi$ max $\pm 0.35$ $\pm 3$ $\pm 0.35$ $\pm 17$ $\pi$ max $\pm 0.35$ $\pm 3$ $2.4$ $2.4$ $V$ min $0.005$ $\pm 0.02$ $9$ $\mu$ typ9 $165$ $0.005$ $\mu$ typ913025 $145$ $ns$ typ5 $5$ $68$ $dB$ typ85 $85$ $dB$ typ99 $9$ $9$ 99 $9$ $pF$ typ9 $0.0001$ $0.2$ $0.0001$ $0.0001$ $0.2$ $0.0001$ $0.2$ $0.0001$ $0.2$ $0.0001$ $0.2$

NOTES

<sup>1</sup>Temperature ranges are as follows: B Versions: -40 °C to +85°C; T Versions: -55°C to +125°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

	B Versions -40°C to		T Versions -55°C to			
Parameter	+25°C	+85°C	+25°C	+125°C	Units	<b>Test Conditions/Comments</b>
ANALOG SWITCH						
Analog Signal Range		$0 \text{ V}$ to $V_{DD}$		$0 \text{ V}$ to $V_{DD}$	v	
R <sub>ON</sub>	28		28		Ω typ	$0 < V_D < 8.5 V, I_S = -10 mA;$
01	42	45	42	45	$\Omega$ max	$V_{DD} = +10.8 V$
$R_{ON}$ vs. $V_D$ ( $V_S$ )	20	10	20	19	% typ	
R <sub>ON</sub> Drift	0.5		0.5		%/°C typ	
R <sub>ON</sub> Match	5		5		% typ	$V_{\rm D} = 0 \text{ V}, \text{ I}_{\rm S} = -10 \text{ mA}$
LEAKAGE CURRENTS			-		,JF	2 7 0
	10.04		10.04			$V_{DD} = +13.2 V$
Source OFF Leakage $I_S$ (OFF)	$\pm 0.04$		$\pm 0.04$	. 1 5	nA typ	$V_{\rm D} = 12.2/1 \text{ V}, V_{\rm S} = 1/12.2 \text{ V};$
	±0.25	$\pm 2$	±0.25	±15	nA max	Test Circuit 2
Drain OFF Leakage $I_D$ (OFF)	±0.04		±0.04		nA typ	$V_D = 12.2/1 \text{ V}, V_S = 1/12.2 \text{ V};$
	±0.25	$\pm 2$	±0.25	±15	nA max	Test Circuit 2
Channel ON Leakage I <sub>D</sub> , Is (ON)	±0.01		±0.01		nA typ	$V_D = V_S = +12.2 \text{ V/}+1 \text{ V};$
	±0.3	±3	±0.3	$\pm 17$	nA max	Test Circuit 3
DIGITAL INPUTS						
Input High Voltage, V <sub>INH</sub>		2.4		2.4	V min	
Input Low Voltage, V <sub>INL</sub>		0.8		0.8	V max	
Input Current						
I <sub>INL</sub> or I <sub>INH</sub>	0.005		0.005		μA typ	$V_{IN} = V_{INI}$ or $V_{INH}$
TINE OF TINH	0.005	$\pm 0.01$	0.005	$\pm 0.01$	μA max	
C <sub>IN</sub> Digital Input Capacitance	9	_0.01	9	_0.01	pF typ	
	-		-		P <sup>2</sup> OP	
DYNAMIC CHARACTERISTICS <sup>2</sup>						$V_{DD} = +12 V, V_{SS} = 0 V$
t <sub>ON</sub>	165		165	<b></b>	ns typ	$R_L$ = 300 Ω, $C_L$ = 35 pF;
		240		240	ns max	$V_s = +8 V$ ; Test Circuit 4
t <sub>OFF</sub>	60		60		ns typ	$R_L = 300 \Omega, C_L = 35 pF;$
		115		115	ns max	$V_s = +8 V$ ; Test Circuit 4
Break-Before-Make Time Delay, $t_D$	25		25		ns typ	$R_L = 300 \Omega$ , $C_L = 35 pF$ ;
(ADG433 Only)						$V_{S1} = V_{S2} = +10 V;$
						Test Circuit 5
Charge Injection	25		25		pC typ	$V_S = 0 V, R_S = 0 \Omega, C_L = 10 nF;$ Test Circuit 6
OFF Isolation	68		68		dB typ	$R_L = 50 \Omega, C_L = 5 pF, f = 1 MHz$
						Test Circuit 7
Channel-to-Channel Crosstalk	85		85		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$
					_	Test Circuit 8
C <sub>s</sub> (OFF)	9		9		pF typ	f = 1 MHz
C <sub>D</sub> (OFF)	9		9		pF typ	f = 1 MHz
$C_D, C_S (ON)$	35		35		pF typ	f = 1 MHz
POWER REQUIREMENTS						$V_{DD}$ = +13.2 V Digital Inputs = 0 V or 5 V
I <sub>DD</sub>	0.0001		0.0001		μA typ	0 , or 3 ,
	0.03	0.1	0.03	0.1	µA max	
I <sub>L</sub>	0.0001		0.0001		μA typ	
-L	0.0001	0.1	0.03	0.1	μA max	$V_{L} = +5.25 V$
Power Dissipation		1.9		1.9	µW max	
				112	pri mus	

### Single Supply ( $V_{DD}$ = +12 V ± 10%, $V_{SS}$ = 0 V, $V_L$ = +5 V ± 10%, GND = 0 V, unless otherwise noted)

ADG431

0

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NOTES <sup>1</sup>Temperature ranges are as follows: B Versions: -40 °C to +85°C; T Versions: -55°C to +125°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

#### Truth Table (ADG431/ADG432)

l In	ADG432 In	Switch Condition	Logic	Switch 1, 4	Switch 2, 3
	1	ON	0	OFF	ON
	0	OFF	1	ON	OFF

#### Truth Table (ADG433)

#### ABSOLUTE MAXIMUM RATINGS

$(T_A = +25^{\circ}C \text{ unless otherwise noted})$
$V_{DD}$ to $V_{SS}$ +44 V
$V_{DD}$ to GND0.3 V to +25 V
V <sub>SS</sub> to GND +0.3 V to -25 V
$V_L$ to GND0.3 V to $V_{DD}$ + 0.3 V
Analog, Digital Inputs <sup>2</sup> $V_{SS} - 2 V$ to $V_{DD} + 2 V$ or
30 mA, Whichever Occurs First
Continuous Current, S or D 30 mA
Peak Current, S or D 100 mA
(Pulsed at 1 ms, 10% Duty Cycle max)
Operating Temperature Range
Industrial (B Version)40°C to +85°C
Extended (T Version) $\dots -55^{\circ}$ C to $+125^{\circ}$ C
Storage Temperature Range65°C to +150°C
Junction Temperature
Cerdip Package, Power Dissipation

$\theta_{IA}$ , Thermal Impedance
Lead Temperature, Soldering (10 sec) +300°C
Plastic Package, Power Dissipation
$\theta_{JA}$ , Thermal Impedance
Lead Temperature, Soldering (10 sec) +260°C
SOIC Package, Power Dissipation
$\theta_{JA}$ , Thermal Impedance
Lead Temperature, Soldering
Vapor Phase (60 sec) +215°C
Infrared (15 sec) +220°C

NOTES

<sup>1</sup>Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

<sup>2</sup>Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

#### CAUTION\_

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG431/ADG432/ADG433 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



#### PIN CONFIGURATION (DIP/SOIC)

#### **ORDERING GUIDE**

Model <sup>1</sup>	Temperature Range	Package Options <sup>2</sup>
ADG431BN	-40°C to +85°C	N-16
ADG431BR	-40°C to +85°C	R-16A
ADG431TQ	–55°C to +125°C	Q-16
ADG431ABR	-40°C to +85°C	R-16A <sup>3</sup>
ADG432BN	-40°C to +85°C	N-16
ADG432BR	-40°C to +85°C	R-16A
ADG432TQ	–55°C to +125°C	Q-16
ADG432ABR	-40°C to +85°C	R-16A <sup>3</sup>
ADG433BN	-40°C to +85°C	N-16
ADG433BR	-40°C to +85°C	R-16A
ADG433ABR	-40°C to +85°C	R-16A <sup>3</sup>

NOTES

<sup>1</sup>To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers. <sup>2</sup>N = Plastic DIP; R = 0.15" Small Outline IC (SOIC); Q = Cerdip.

<sup>3</sup>Trench isolated, latch-up proof parts. See Trench Isolation section.

V <sub>DD</sub>	Most positive power supply potential.	C <sub>s</sub> (OFF)	"OFF" switch source capacitance.
V <sub>SS</sub>	Most negative power supply potential in dual	C <sub>D</sub> (OFF)	"OFF" switch drain capacitance.
	supplies. In single supply applications, it may be	$C_D, C_S(ON)$	"ON" switch capacitance.
	connected to GND.	C <sub>IN</sub>	Input Capacitance to ground of a digital input.
VL	Logic power supply (+5 V).	t <sub>ON</sub>	Delay between applying the digital control input
GND	Ground (0 V) reference.		and the output switching on.
S	Source terminal. May be an input or output.	t <sub>OFF</sub>	Delay between applying the digital control input
D	Drain terminal. May be an input or output.		and the output switching off.
IN	Logic control input.	t <sub>D</sub>	"OFF" time or "ON" time measured between the
R <sub>ON</sub>	Ohmic resistance between D and S.		90% points of both switches, when switching
$R_{ON}$ vs. $V_D$ ( $V_S$ )	The variation in R <sub>ON</sub> due to a change in the ana-		from one address state to another.
	log input voltage with a constant load current.	Crosstalk	A measure of unwanted signal which is coupled
R <sub>ON</sub> Drift	Change in R <sub>ON</sub> vs. temperature.		through from one channel to another as a result
R <sub>ON</sub> Match	Difference between the R <sub>ON</sub> of any two switches.		of parasitic capacitance.
I <sub>S</sub> (OFF)	Source leakage current with the switch "OFF."	Off Isolation	A measure of unwanted signal coupling through an
I <sub>D</sub> (OFF)	Drain leakage current with the switch "OFF."		"OFF" switch.
$I_D, I_S$ (ON)	Channel leakage current with the switch "ON."	Charge	A measure of the glitch impulse transferred from the
$V_{\rm D}$ (V <sub>S</sub> )	Analog voltage on terminals D, S.	Injection	digital input to the analog output during switching.

#### TERMINOLOGY

### **Typical Performance Graphs**

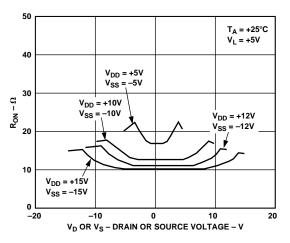


Figure 1. On Resistance as a Function of  $V_D$  ( $V_S$ ) Dual Supplies

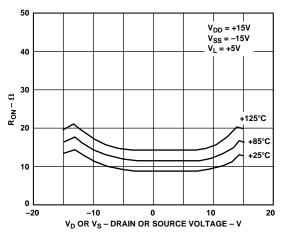


Figure 2. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures

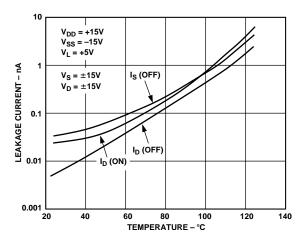


Figure 3. Leakage Currents as a Function of Temperature

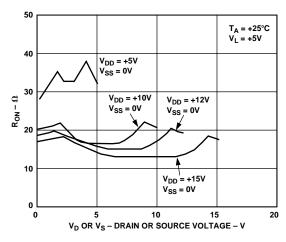


Figure 4. On Resistance as a Function of  $V_{\text{D}}$  (V\_{\text{S}}) Single Supply

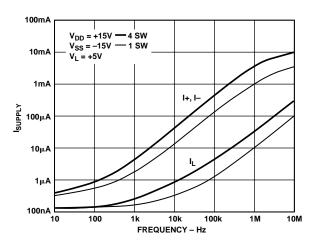


Figure 5. Supply Current vs. Input Switching Frequency

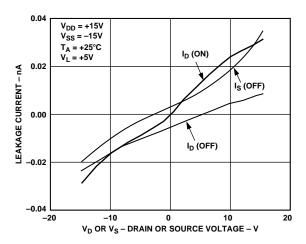


Figure 6. Leakage Currents as a Function of  $V_D(V_S)$ 

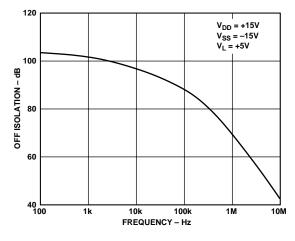


Figure 7. Off Isolation vs. Frequency

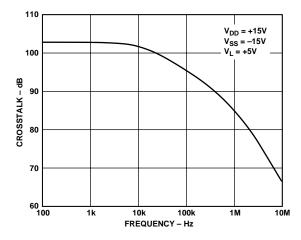


Figure 8. Crosstalk vs. Frequency

#### TRENCH ISOLATION

In the ADG431A, ADG432A and ADG433A, an insulating oxide layer (trench) is placed between the NMOS and PMOS transistors of each CMOS switch. Parasitic junctions, which occur between the transistors in junction isolated switches, are eliminated, the result being a completely latch-up proof switch.

In junction isolation, the N and P wells of the PMOS and NMOS transistors from a diode that is reverse-biased under normal operation. However, during overvoltage conditions, this diode becomes forward biased. A silicon-controlled rectifier (SCR) type circuit is formed by the two transistors causing a significant amplification of the current which, in turn, leads to latch up. With trench isolation, this diode is removed, the result being a latch-up proof switch.

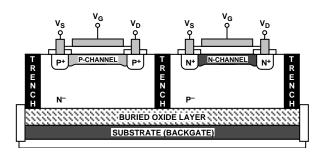


Figure 9. Trench Isolation

#### APPLICATION

Figure 10 illustrates a precise, fast sample-and-hold circuit. An AD845 is used as the input buffer while the output operational amplifier is an AD711. During the track mode, SW1 is closed and the output  $V_{OUT}$  follows the input signal  $V_{IN}$ . In the hold mode, SW1 is opened and the signal is held by the hold capacitor  $C_{\rm H}$ .

Due to switch and capacitor leakage, the voltage on the hold capacitor will decrease with time. The ADG431/ADG432/ ADG433 minimizes this droop due to its low leakage specifications. The droop rate is further minimized by the use of a polystyrene hold capacitor. The droop rate for the circuit shown is typically 30  $\mu$ V/ $\mu$ s.

A second switch SW2, which operates in parallel with SW1, is included in this circuit to reduce pedestal error. Since both switches will be at the same potential, they will have a differential effect on the op amp AD711 which will minimize charge injection effects. Pedestal error is also reduced by the compensation network  $R_C$  and  $C_C$ . This compensation network also reduces the hold time glitch while optimizing the acquisition time. Using the illustrated op amps and component values, the pedestal error has a maximum value of 5 mV over the ±10 V input range. Both the acquisition and settling times are 850 ns.

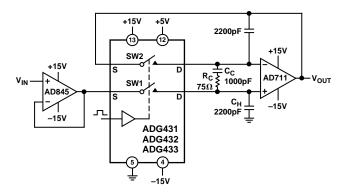
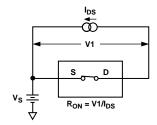
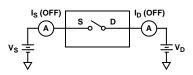


Figure 10. Fast, Accurate Sample-and-Hold

### **Test Circuits**

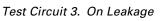


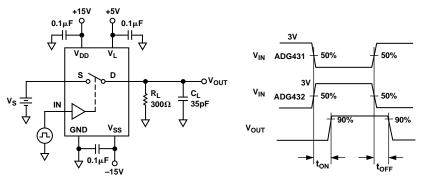


 $v_{s} = \underbrace{\begin{bmatrix} s & p & 0 \\ \hline p & 0 \end{bmatrix}}_{I_{D}} \underbrace{I_{D}(ON)}_{A} = \underbrace{I_{D}(ON)}_{I_{D}(ON)}$ 

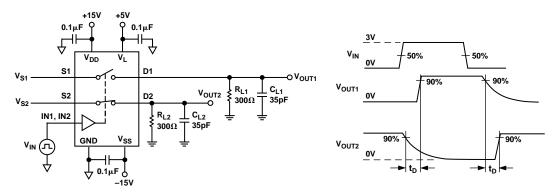
Test Circuit 1. On Resistance

Test Circuit 2. Off Leakage

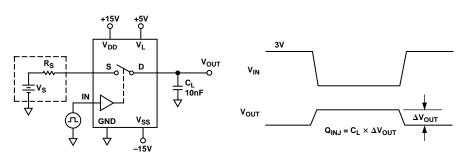




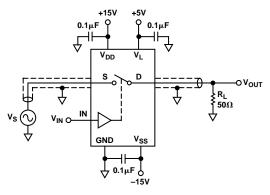
Test Circuit 4. Switching Times



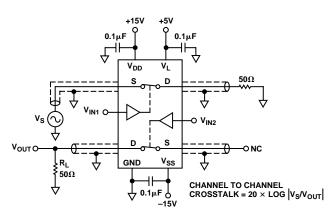
Test Circuit 5. Break-Before-Make Time Delay



Test Circuit 6. Charge Injection



Test Circuit 7. Off Isolation

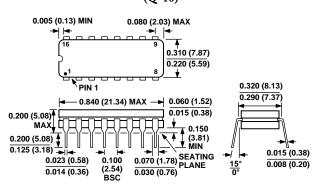


Test Circuit 8. Channel-to-Channel Crosstalk

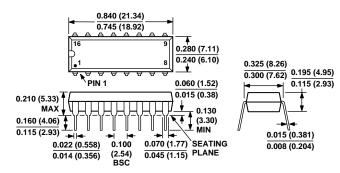
#### **OUTLINE DIMENSIONS**

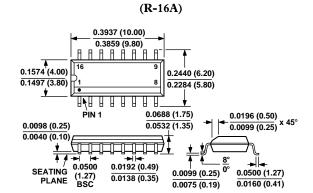
Dimensions shown in inches and (mm).





#### 16-Lead Plastic DIP (Narrow) (N-16)





16-Lead SOIC